| PCN Number:              |        |              | 20130410004 |                           |                          |             |              |              | PCN Date:                |                | 04/15/2013 |
|--------------------------|--------|--------------|-------------|---------------------------|--------------------------|-------------|--------------|--------------|--------------------------|----------------|------------|
| Title: TPS22930A D       |        | Data Sheet   |             |                           |                          |             |              |              |                          |                |            |
| <b>Customer Contact:</b> |        |              | PCN Manager |                           | Phone:                   | +1(214) 480 | 14) 480-6037 |              | Qua                      | ality Services |            |
| Change Type:             |        |              |             |                           |                          |             |              |              |                          |                |            |
|                          | Asse   | ssembly Site |             |                           | Assembly Process         |             |              |              | Assembly Materials       |                |            |
|                          | Design |              |             | $\boxtimes$               | Electrical Specification |             |              |              | Mechanical Specification |                |            |
| Test Site                |        |              |             | Packing/Shipping/Labeling |                          |             |              | Test Process |                          |                |            |
| Wafer Bump Site          |        |              |             |                           | Wafer Bump Material      |             |              |              | Wafer Bump Process       |                |            |
| Wafer Fab Site           |        |              |             |                           | Wafer Fab Materials      |             |              |              | Wafer Fab Process        |                |            |
| DONED 1 II               |        |              |             |                           |                          |             |              |              |                          |                |            |

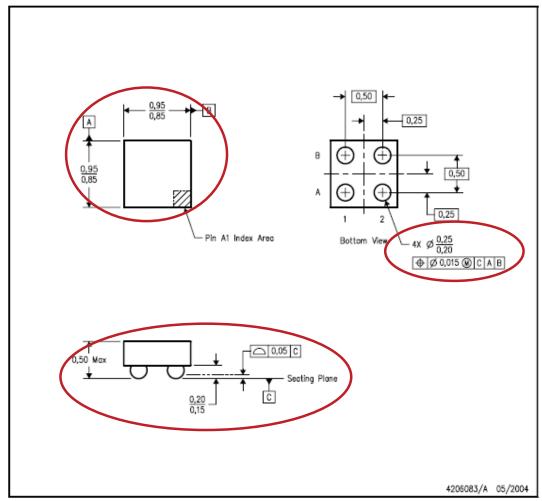
# **PCN Details**

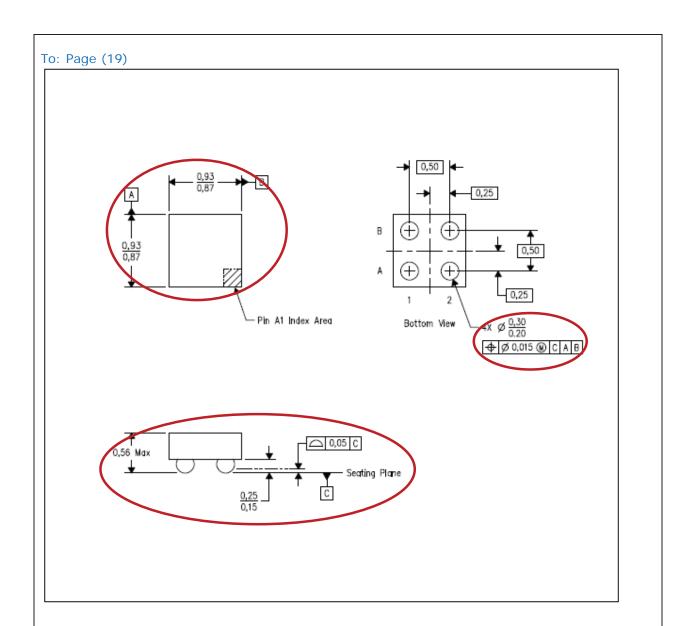
# **Description of Change:**

The product datasheet(s) is being updated to change the dimension tolerances of the package drawing.

The following change history provides further details. These changes may be reviewed at the datasheet links provided.

From: Page (19)





The datasheet number will be changing.

| Device Family | Change From: | Change To: |
|---------------|--------------|------------|
| TPS22930A     | SLVSBL3      | SLVSBL3    |

The updated datasheet(s) can be accessed by the following link(s):

http://www.ti.com/product/tps22930a

#### **Reason for Change:**

To more accurately reflect device characteristics. There is a change to the mechanical spec NOT electrical spec

## Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Electrical specification performance changes as indicated above.

#### **Changes to product identification resulting from this PCN:**

Mechanical specification changes as indicated above

## **Product Affected:**

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

| Location     | E-Mail                         |
|--------------|--------------------------------|
| USA          | PCNAmericasContact@list.ti.com |
| Europe       | PCNEuropeContact@list.ti.com   |
| Asia Pacific | PCNAsiaContact@list.ti.com     |
| Japan        | PCNJapanContact@list.ti.com    |